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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	4.75V ~ 5.25V
Number of Logic Elements/Blocks	-
Number of Macrocells	64
Number of Gates	-
Number of I/O	69
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy37064p100-125ac

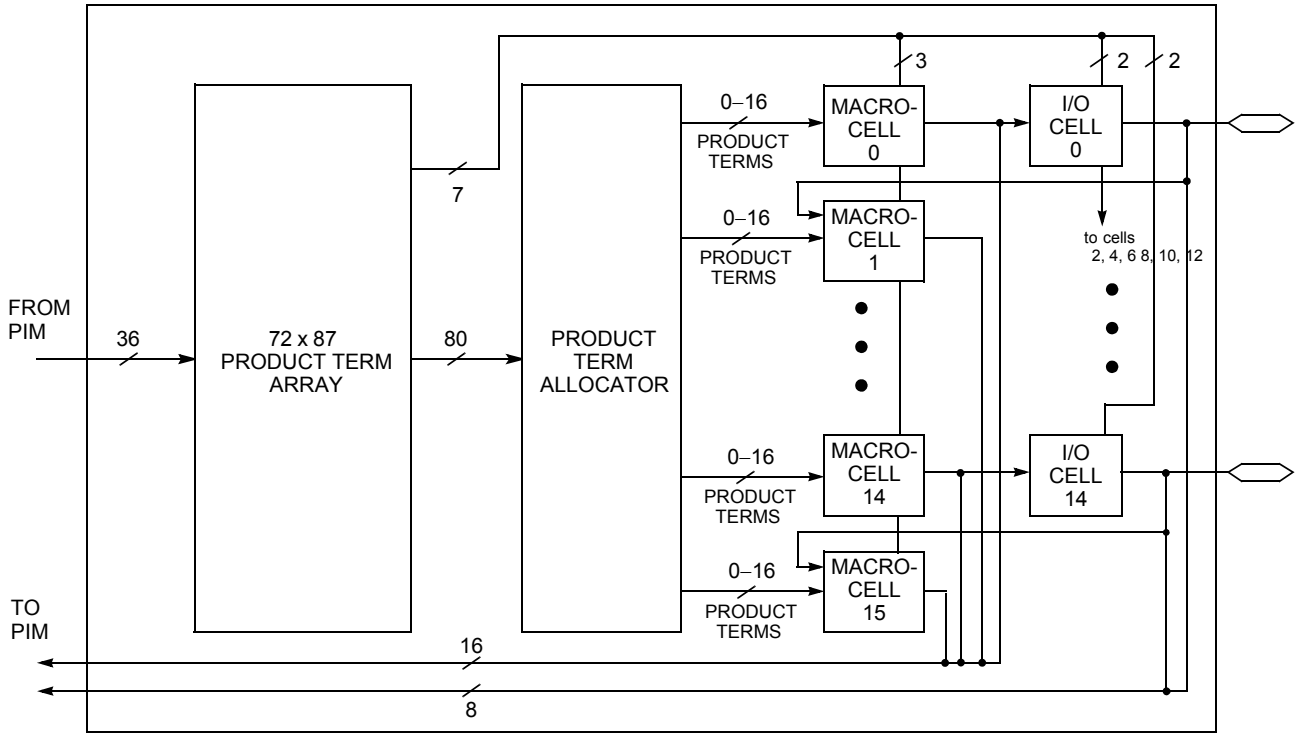


Figure 1. Logic Block with 50% Buried Macrocells

Low-Power Option

Each logic block can operate in high-speed mode for critical path performance, or in low-power mode for power conservation. The logic block mode is set by the user on a logic block by logic block basis.

Product Term Allocator

Through the product term allocator, software automatically distributes product terms among the 16 macrocells in the logic block as needed. A total of 80 product terms are available from the local product term array. The product term allocator provides two important capabilities without affecting performance: product term steering and product term sharing.

Product Term Steering

Product term steering is the process of assigning product terms to macrocells as needed. For example, if one macrocell requires ten product terms while another needs just three, the product term allocator will “steer” ten product terms to one macrocell and three to the other. On Ultra37000 devices, product terms are steered on an individual basis. Any number between 0 and 16 product terms can be steered to any macrocell. Note that 0 product terms is useful in cases where a particular macrocell is unused or used as an input register.

Product Term Sharing

Product term sharing is the process of using the same product term among multiple macrocells. For example, if more than one output has one or more product terms in its equation that are common to other outputs, those product terms are only programmed once. The Ultra37000 product term allocator allows sharing across groups of four output macrocells in a variable fashion. The software automatically takes advantage of this capability—the user does not have to intervene.

Note that neither product term sharing nor product term steering have any effect on the speed of the product. All worst-case steering and sharing configurations have been incorporated in the timing specifications for the Ultra37000 devices.

Ultra37000 Macrocell

Within each logic block there are 16 macrocells. Macrocells can either be I/O Macrocells, which include an I/O Cell which is associated with an I/O pin, or buried Macrocells, which do not connect to an I/O. The combination of I/O Macrocells and buried Macrocells varies from device to device.

Buried Macrocell

Figure 2 displays the architecture of buried macrocells. The buried macrocell features a register that can be configured as combinatorial, a D flip-flop, a T flip-flop, or a level-triggered latch.

The register can be asynchronously set or asynchronously reset at the logic block level with the separate set and reset product terms. Each of these product terms features programmable polarity. This allows the registers to be set or reset based on an AND expression or an OR expression.

Clocking of the register is very flexible. Four global synchronous clocks and a product term clock are available to clock the register. Furthermore, each clock features programmable polarity so that registers can be triggered on falling as well as rising edges (see the Clocking section). Clock polarity is chosen at the logic block level.

The buried macrocell also supports input register capability. The buried macrocell can be configured to act as an input register (D-type or latch) whose input comes from the I/O pin associated with the neighboring macrocell. The output of all buried macrocells is sent directly to the PIM regardless of its configuration.

I/O Macrocell

Figure 2 illustrates the architecture of the I/O macrocell. The I/O macrocell supports the same functions as the buried macrocell with the addition of I/O capability. At the output of the macrocell, a polarity control mux is available to select active LOW or active HIGH signals. This has the added advantage of allowing significant logic reduction to occur in many applications.

The Ultra37000 macrocell features a feedback path to the PIM separate from the I/O pin input path. This means that if the macrocell is buried (fed back internally only), the associated I/O pin can still be used as an input.

Bus Hold Capabilities on all I/Os

Bus-hold, which is an improved version of the popular internal pull-up resistor, is a weak latch connected to the pin that does not degrade the device's performance. As a latch, bus-hold maintains the last state of a pin when the pin is placed in a high-impedance state, thus reducing system noise in bus-interface applications. Bus-hold additionally allows unused device pins to remain unconnected on the board, which is particularly useful during prototyping as designers can route new signals to the device without cutting trace connections to V_{CC} or GND. For more information, see the application note *Understanding Bus-Hold—A Feature of Cypress CPLDs*.

Programmable Slew Rate Control

Each output has a programmable configuration bit, which sets the output slew rate to fast or slow. For designs concerned with meeting FCC emissions standards the slow edge provides for lower system noise. For designs requiring very high performance the fast edge rate provides maximum system performance.

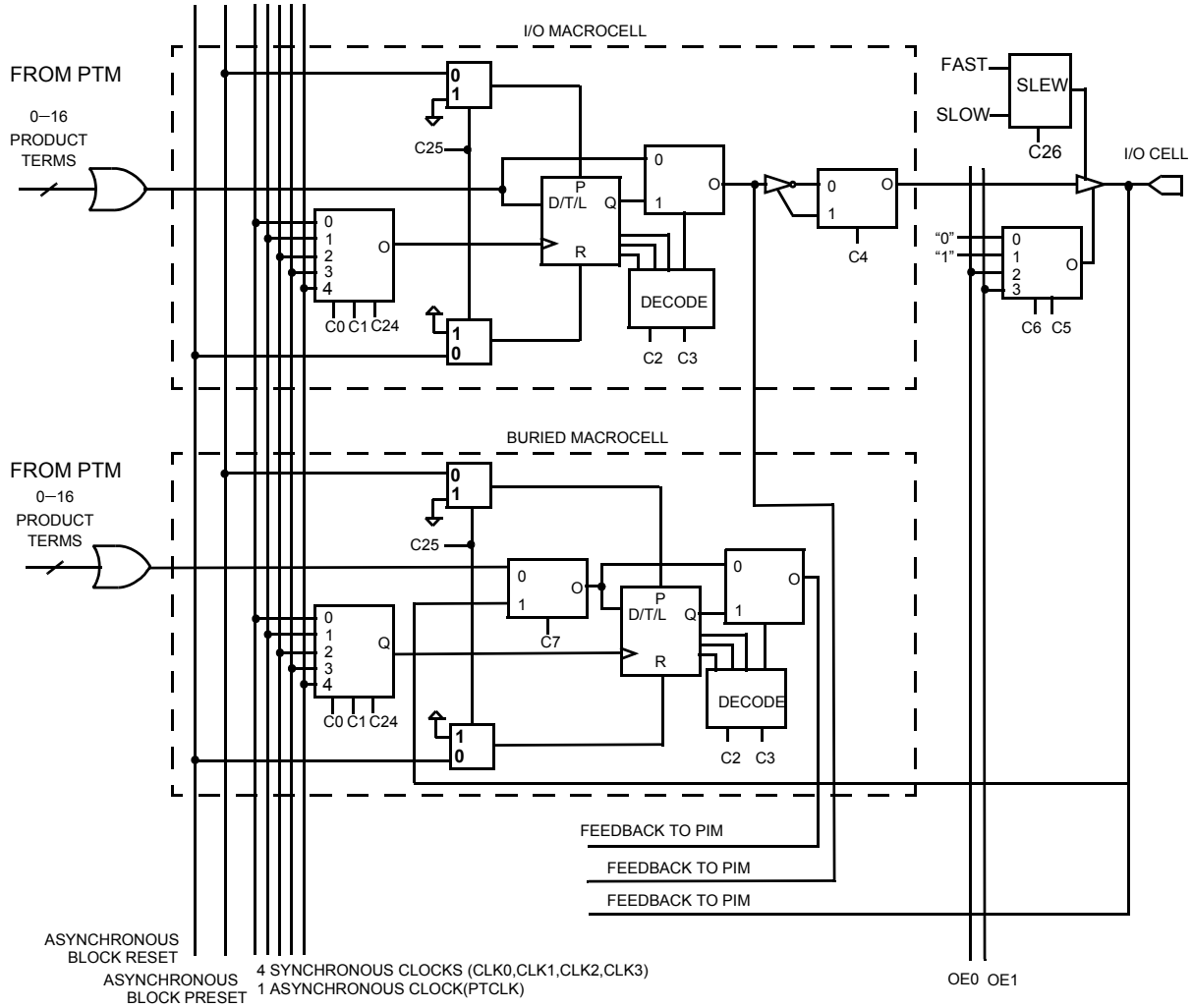
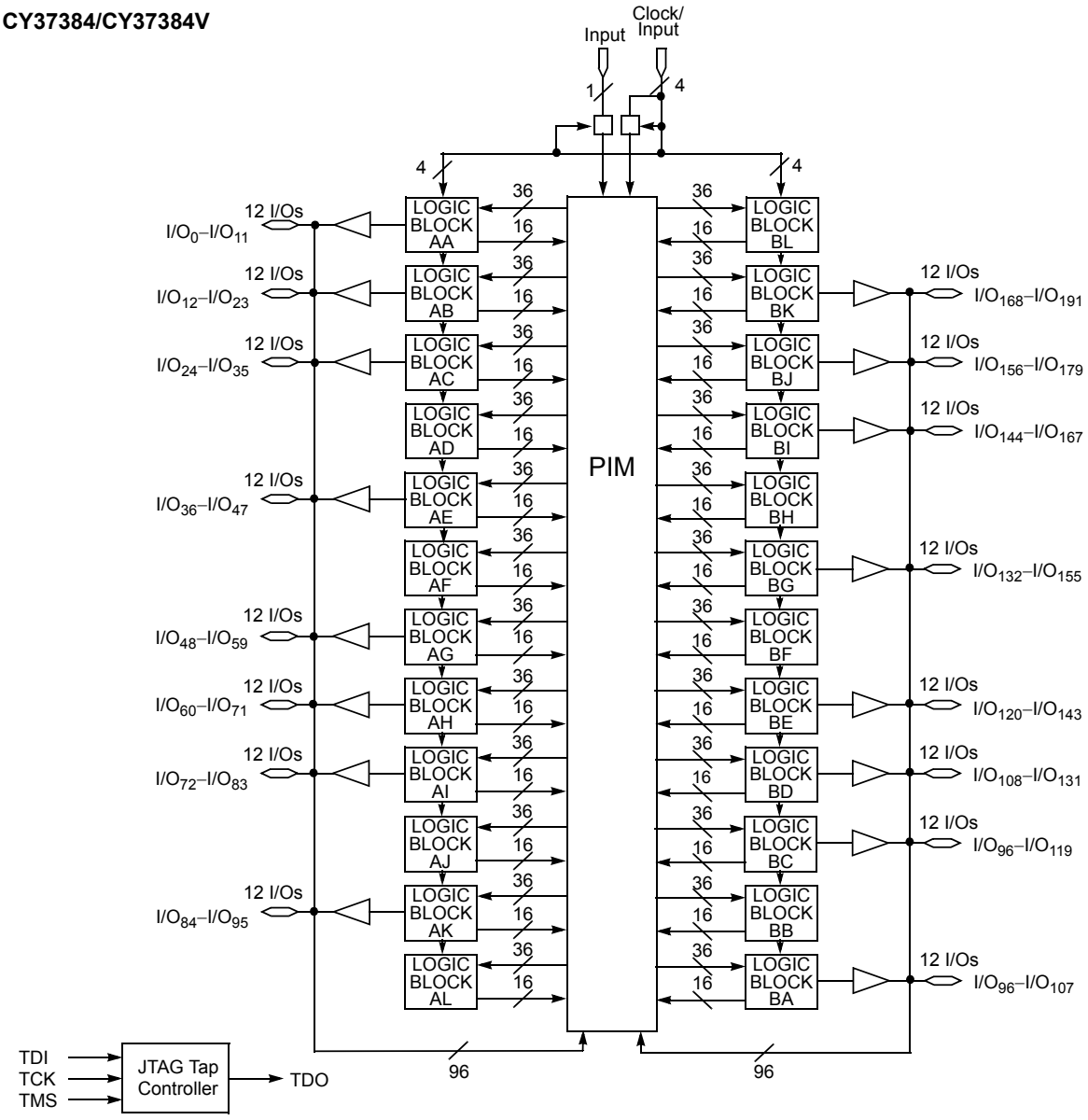


Figure 2. I/O and Buried Macrocells

Logic Block Diagrams (continued)

CY37384/CY37384V



Inductance[5]

Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	V_{IN} = 3.3V at f = 1 MHz	2	5	2	8	5	8	9	11	nH

Capacitance[5]

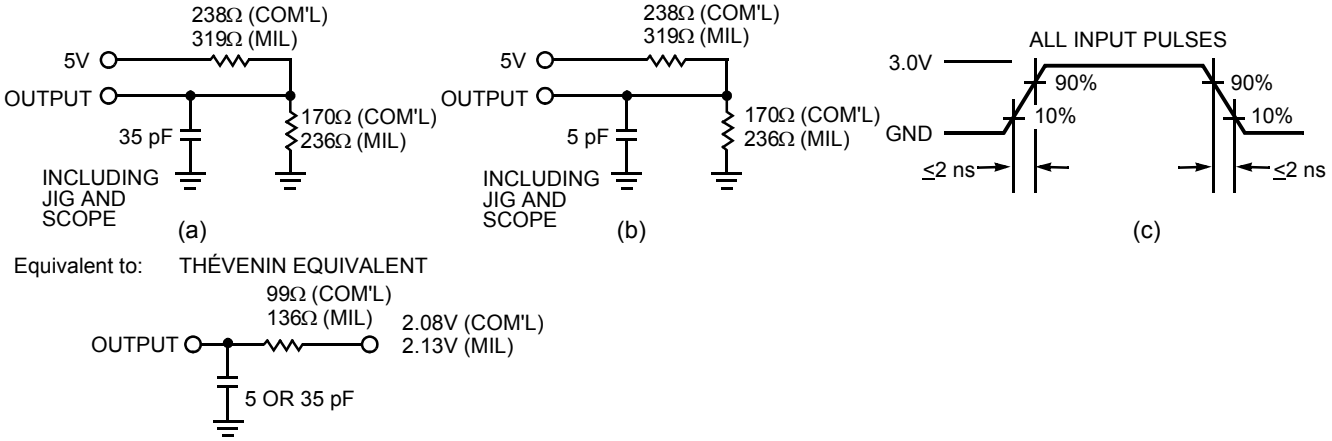
Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	V_{IN} = 3.3V at f = 1 MHz at T_A = 25°C	8	pF
C_{CLK}	Clock Signal Capacitance	V_{IN} = 3.3V at f = 1 MHz at T_A = 25°C	12	pF
C_{DP}	Dual Functional Pins[9]	V_{IN} = 3.3V at f = 1 MHz at T_A = 25°C	16	pF

Endurance Characteristics[5]

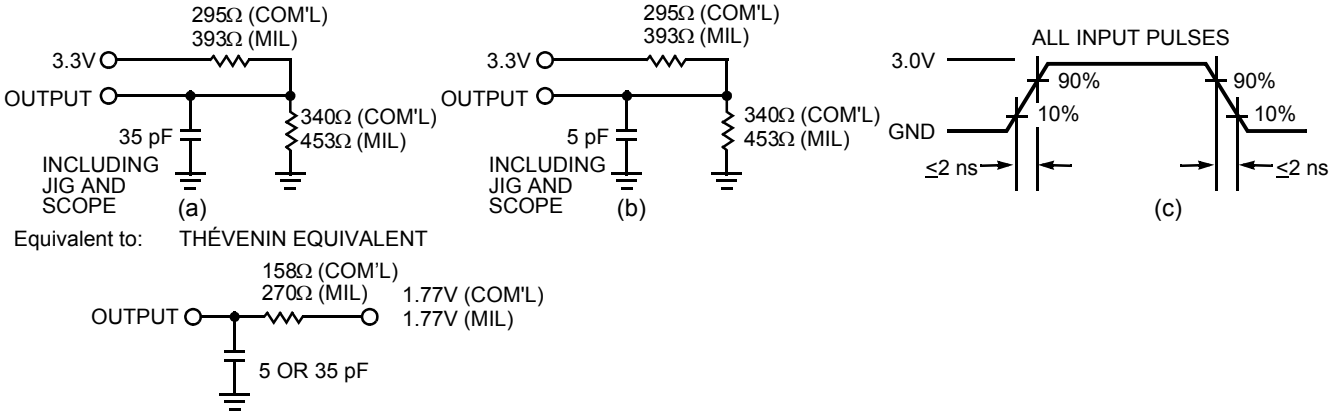
Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions[2]	1,000	10,000	Cycles

AC Characteristics

5.0V AC Test Loads and Waveforms

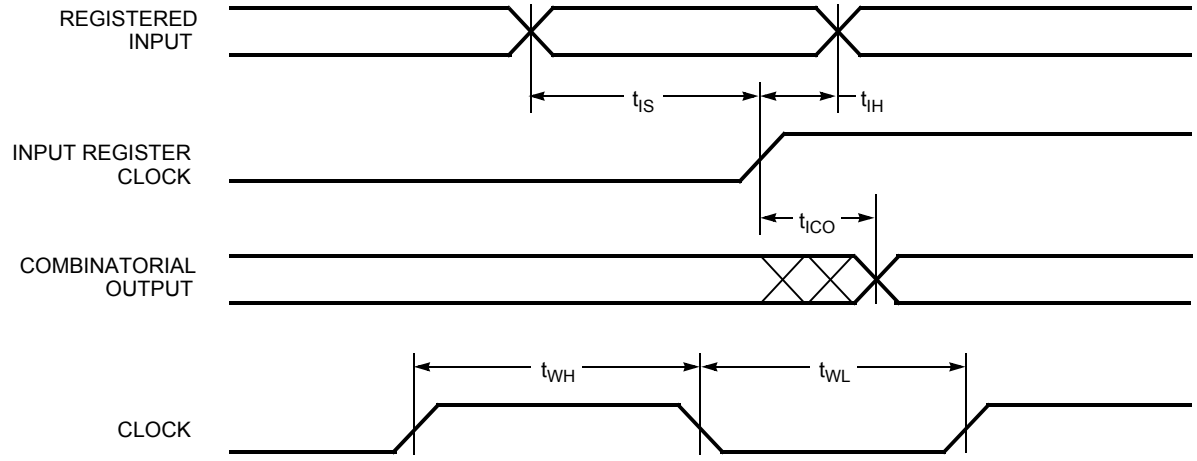


3.3V AC Test Loads and Waveforms

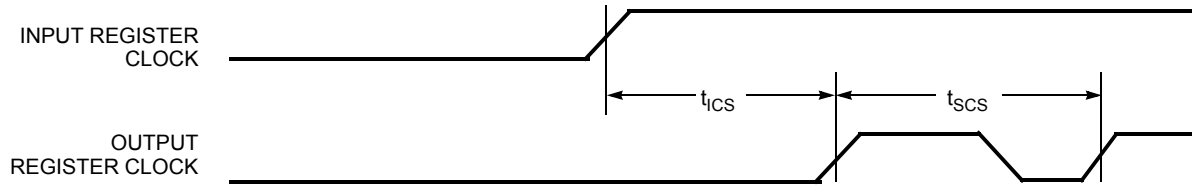


Switching Waveforms (continued)

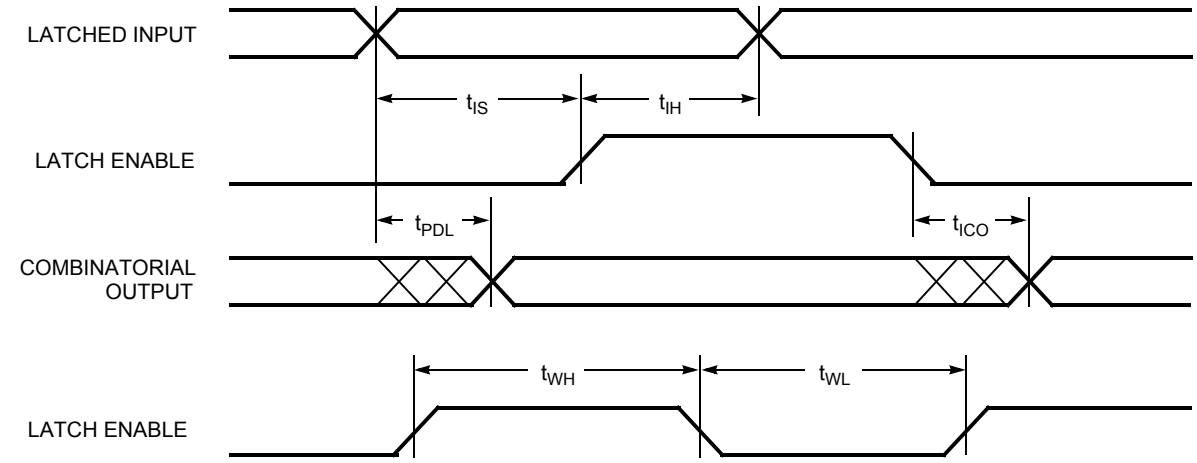
Registered Input



Clock to Clock



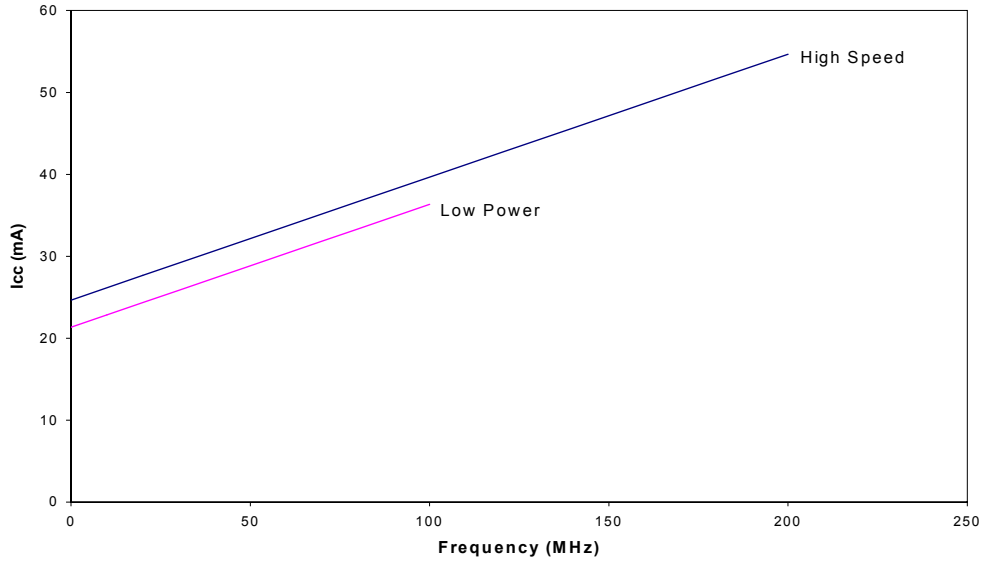
Latched Input



Power Consumption

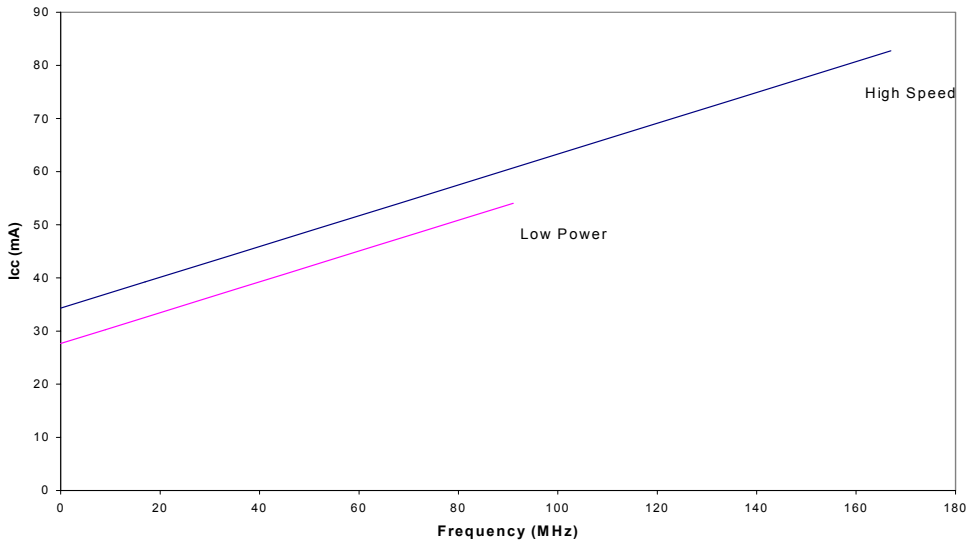
Typical 5.0V Power Consumption

CY37032



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 5.0V, T_A = Room Temperature

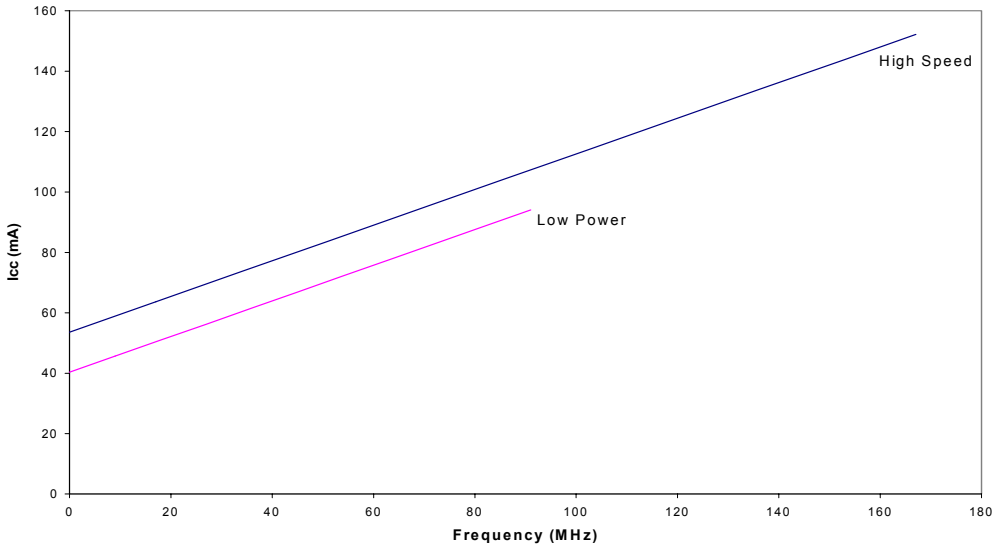
CY37064



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 5.0V, T_A = Room Temperature

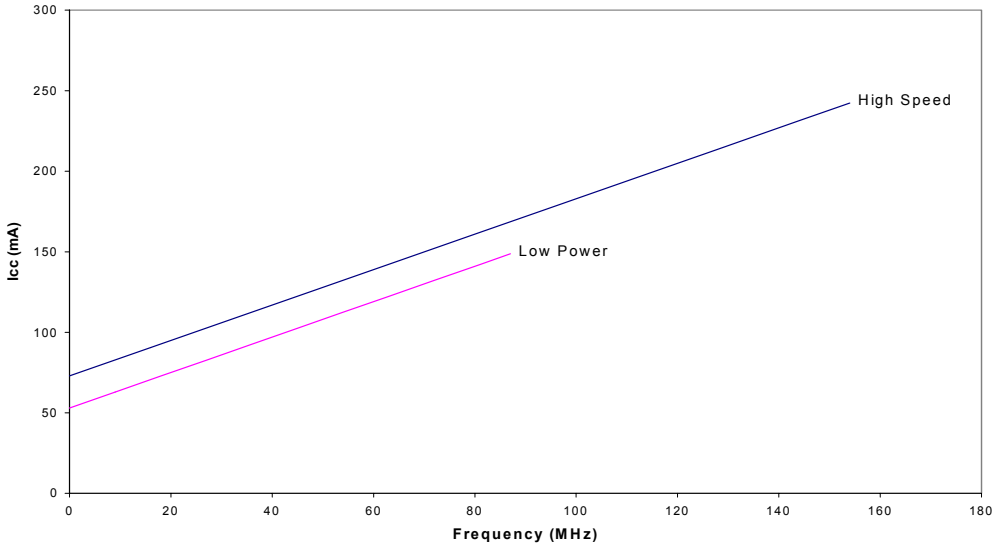
Typical 5.0V Power Consumption (continued)

CY37128



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 5.0V, T_A = Room Temperature

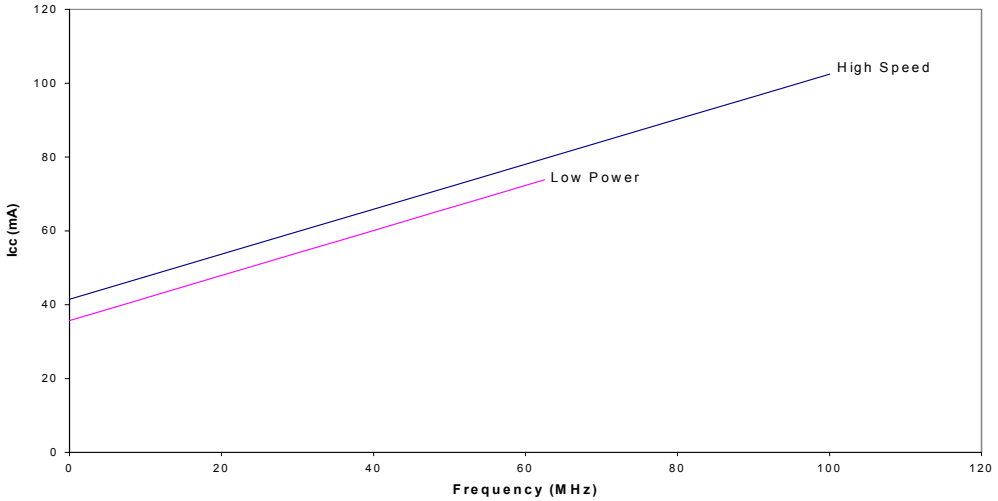
CY37192



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 5.0V, T_A = Room Temperature

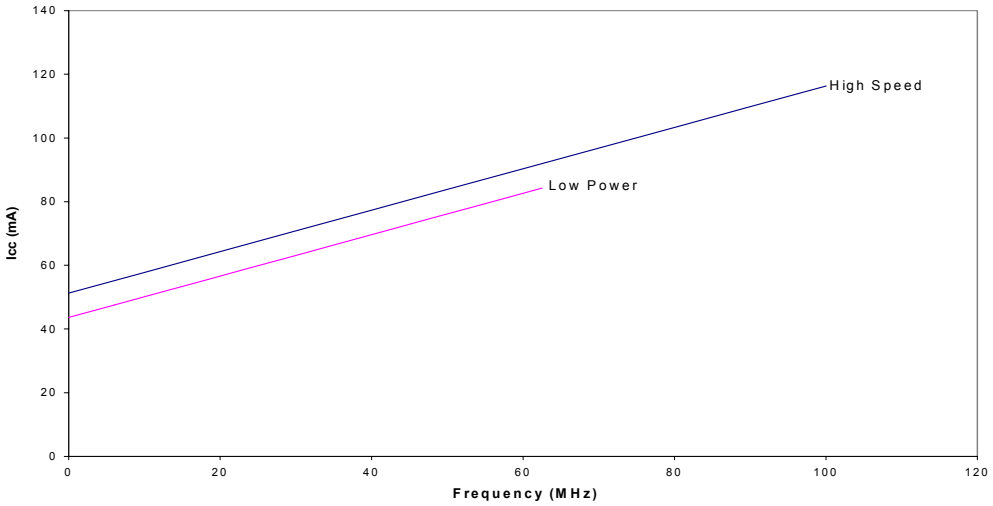
Typical 3.3V Power Consumption (continued)

CY37192V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 3.3V, T_A = Room Temperature

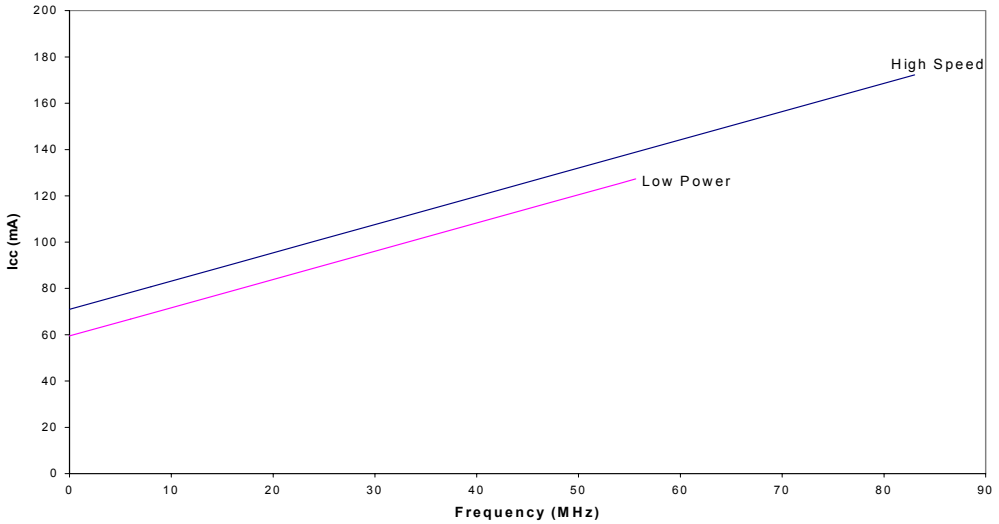
CY37256V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 3.3V, T_A = Room Temperature

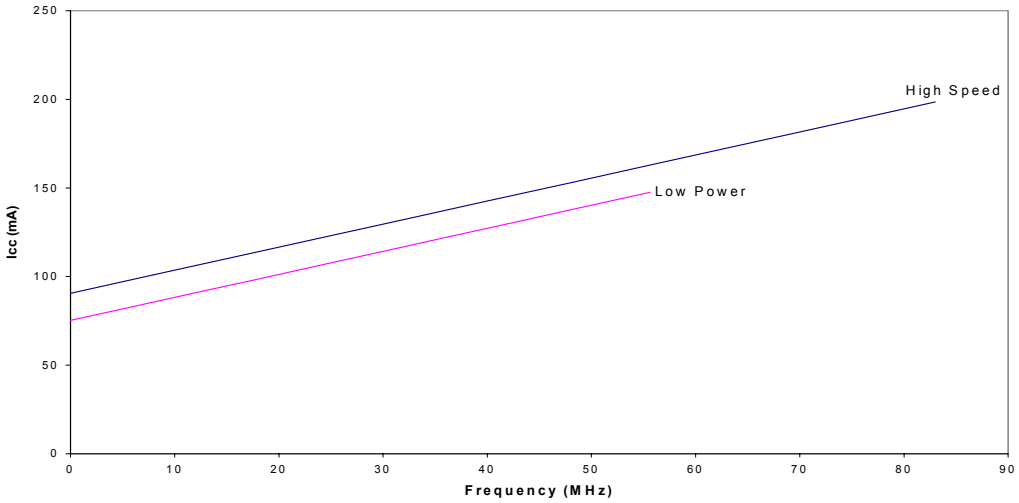
Typical 3.3V Power Consumption (continued)

CY37384V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 3.3V, T_A = Room Temperature

CY37512V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 3.3V, T_A = Room Temperature

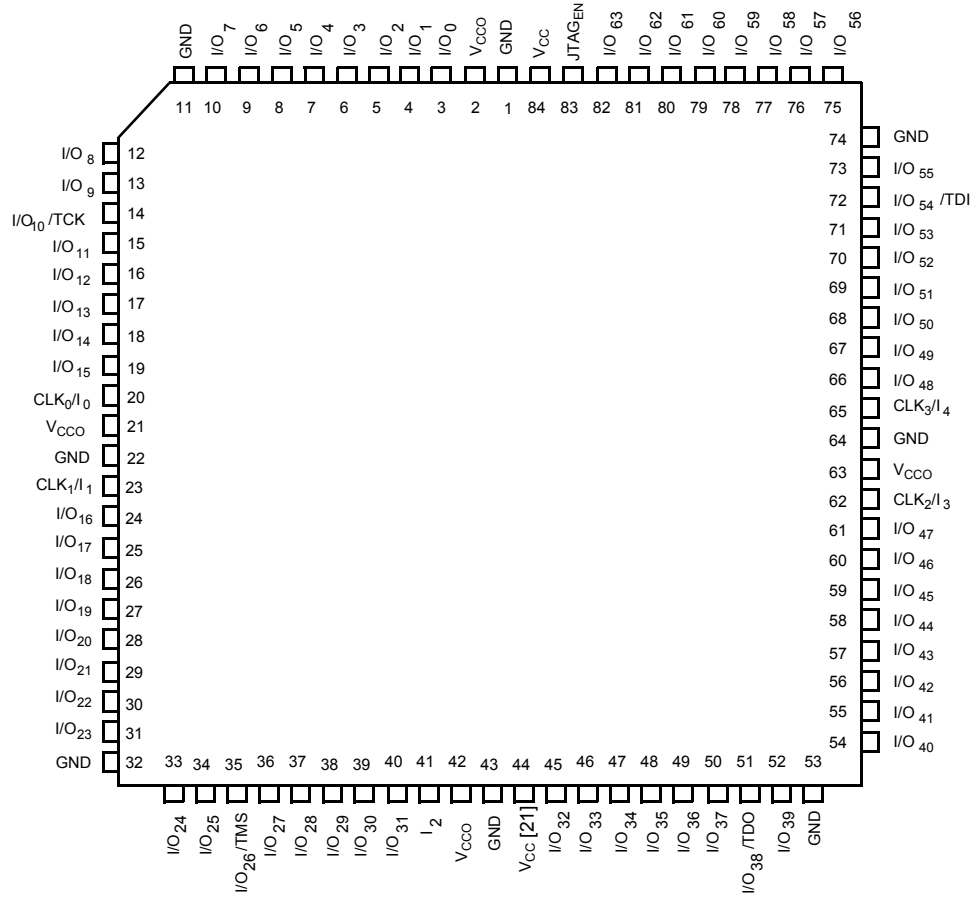
Pin Configurations[20] (continued)

48-ball Fine-Pitch BGA (BA50)
Top View

	1	2	3	4	5	6	7	8
A	I/O_5 TCK	V_{CC}	I/O_3	I/O_1	I/O_{31}	I/O_{30}	V_{CC}	I/O_{27} TDI
B	V_{CC}	I/O_4	I/O_2	I/O_0	I/O_{29}	I/O_{28}	I/O_{26}	CLK_1/ I_4
C	CLK_2/ I_0	I/O_7	I/O_6	GND	GND	I/O_{25}	I/O_{24}	I_3
D	$JTAG_{EN}$	I/O_8	I/O_9	GND	GND	I/O_{22}	I/O_{23}	CLK_3/ I_2
E	CLK_0/ I_1	I/O_{12}	I/O_{11}	I/O_{10}	I/O_{16}	I/O_{20}	I/O_{21}	V_{CC}
F	I/O_{13} TMS	V_{CC}	I/O_{14}	I/O_{15}	I/O_{17}	I/O_{18}	V_{CC}	I/O_{19} TDO

Note:
20. For 3.3V versions (Ultra37000V), $V_{CCO} = V_{CC}$.

84-lead PLCC (J83) / CLCC (Y84)
Top View



Note:
21. This pin is a N/C, but Cypress recommends that you connect it to V_{CC} to ensure future compatibility.

Pin Configurations[20] (continued)

100-ball Fine-Pitch BGA (BB100) for CY37064V
Top View

	1	2	3	4	5	6	7	8	9	10
A	NC	NC	I/O_7	I/O_5	I/O_2	I/O_{62}	I/O_{60}	I/O_{58}	I/O_{57}	I/O_{56}
B	I/O_9	I/O_8	I/O_6	I/O_4	I/O_1	I/O_{63}	V_{CC}	I/O_{59}	I/O_{55}	NC
C	I/O_{10}	TCK	V_{CC}	I/O_3	NC	NC	I/O_{61}	V_{CC}	TDI	I/O_{54}
D	I/O_{11}	NC	I/O_{12}	I/O_{13}	I/O_0	NC	I/O_{51}	I/O_{52}	CLK_3/I_4	I/O_{53}
E	I/O_{14}	CLK_0/I_0	I/O_{15}	NC	GND	GND	I/O_{48}	I/O_{49}	CLK_2/I_3	I/O_{50}
F	I/O_{17}	NC	NC	I/O_{16}	GND	GND	NC	NC	I_2	I/O_{47}
G	I/O_{22}	CLK_1/I_1	I/O_{21}	I/O_{19}	I/O_{18}	I/O_{46}	I/O_{45}	I/O_{44}	NC	I/O_{43}
H	I/O_{23}	TMS	V_{CC}	I/O_{20}	NC	I/O_{32}	I/O_{42}	V_{CC}	TDO	I/O_{41}
J	NC	I/O_{26}	I/O_{28}	NC	I/O_{31}	I/O_{33}	I/O_{35}	I/O_{37}	I/O_{39}	I/O_{40}
K	I/O_{24}	I/O_{25}	I/O_{27}	I/O_{29}	I/O_{30}	I/O_{34}	I/O_{36}	I/O_{38}	NC	NC

100-ball Fine-Pitch BGA (BB100) for CY37128V
Top View

	1	2	3	4	5	6	7	8	9	10
A	NC	I/O_9	I/O_8	I/O_6	I/O_3	I/O_{76}	I/O_{74}	I/O_{72}	I/O_{71}	I/O_{70}
B	I/O_{11}	I/O_{10}	I/O_7	I/O_5	I/O_2	I/O_{77}	V_{CC}	I/O_{73}	I/O_{68}	I/O_{69}
C	I/O_{12}	I/O_{13} TCK	V_{CC}	I/O_4	I/O_1	I/O_{78}	I/O_{75}	V_{CC}	I/O_{67} TDI	I/O_{66}
D	I/O_{14}	NC	I/O_{15}	I/O_{16}	I/O_0	I/O_{79}	I/O_{63}	I/O_{64}	CLK_3/I_4	I/O_{65}
E	I/O_{17}	CLK_0/I_0	I/O_{18}	I/O_{19}	GND	GND	I/O_{60}	I/O_{61}	CLK_2/I_3	I/O_{62}
F	I/O_{22}	JTAG EN	I/O_{21}	I/O_{20}	GND	GND	I/O_{59}	I/O_{58}	I_2	I/O_{57}
G	I/O_{27}	CLK_1/I_1	I/O_{26}	I/O_{24}	I/O_{23}	I/O_{56}	I/O_{55}	I/O_{54}	NC	I/O_{53}
H	I/O_{28}	I/O_{33} TMS	V_{CC}	I/O_{25}	I/O_{39}	I/O_{40}	I/O_{52}	V_{CC}	I/O_{47} TDO	I/O_{51}
J	I/O_{29}	I/O_{32}	I/O_{35}	V_{CC}	I/O_{38}	I/O_{41}	I/O_{43}	I/O_{45}	I/O_{48}	I/O_{50}
K	I/O_{30}	I/O_{31}	I/O_{34}	I/O_{36}	I/O_{37}	I/O_{42}	I/O_{44}	I/O_{46}	I/O_{49}	NC

Pin Configurations[20] (continued)

388-Lead PBGA (BG388)

Top View

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26
A	GND	GND	I/O_{19}	I/O_{15}	I/O_{13}	I/O_{34}	I/O_{31}	I/O_{28}	I/O_{25}	I/O_{10}	I/O_{7}	I/O_{4}	I/O_{1}	I/O_{263}	I/O_{260}	I/O_{257}	I/O_{254}	I/O_{239}	I/O_{237}	I/O_{232}	I/O_{229}	I/O_{250}	I/O_{248}	I/O_{244}	GND	GND
B	GND	NC	I/O_{18}	I/O_{17}	I/O_{14}	I/O_{35}	I/O_{32}	I/O_{29}	I/O_{26}	I/O_{11}	I/O_{8}	I/O_{5}	I/O_{2}	V_{CC}	I/O_{261}	I/O_{258}	I/O_{255}	I/O_{252}	I/O_{234}	I/O_{231}	I/O_{228}	I/O_{249}	I/O_{246}	I/O_{245}	I/O_{240}	GND
C	I/O_{23}	I/O_{38}	I/O_{37}	I/O_{16}	I/O_{12}	I/O_{33}	I/O_{30}	I/O_{27}	I/O_{24}	I/O_{9}	I/O_{6}	I/O_{3}	I/O_{0}	I/O_{262}	I/O_{259}	I/O_{256}	I/O_{253}	I/O_{238}	I/O_{235}	I/O_{233}	I/O_{230}	I/O_{251}	I/O_{247}	I/O_{225}	I/O_{224}	I/O_{227}
D	I/O_{39}	I/O_{40}	I/O_{36}	NC	NC	I/O_{21}	I/O_{20}	V_{CCO}	V_{CCO}	NC	GND	GND	V_{CCO}	V_{CCO}	GND	GND	NC	V_{CCO}	V_{CCO}	I/O_{236}	I/O_{243}	NC	NC	I/O_{226}	I/O_{222}	I/O_{223}
E	I/O_{42}	TCK	I/O_{41}	NC																			NC	TDI	I/O_{221}	I/O_{220}
F	I/O_{45}	I/O_{44}	I/O_{43}	I/O_{22}																			I/O_{242}	I/O_{219}	I/O_{218}	I/O_{217}
G	I/O_{48}	I/O_{47}	I/O_{46}	I/O_{63}																			I/O_{241}	I/O_{216}	I/O_{215}	I/O_{214}
H	I/O_{49}	I/O_{50}	I/O_{51}	V_{CCO}																			V_{CCO}	I/O_{211}	I/O_{212}	I/O_{213}
J	I/O_{52}	I/O_{53}	I/O_{54}	V_{CCO}																			V_{CCO}	I/O_{208}	I/O_{209}	I/O_{210}
K	I/O_{55}	I/O_{56}	I/O_{57}	NC																			NC	I/O_{205}	I/O_{206}	I/O_{207}
L	I0	I/O_{59}	I/O_{58}	GND							GND	GND	GND	GND	GND	GND							GND	I/O_{204}	I4	I/O_{197}
M	I/O_{61}	I/O_{60}	I1	GND							GND	GND	GND	GND	GND	GND							GND	I3	I/O_{203}	I/O_{202}
N	I/O_{64}	V_{CC}	I/O_{62}	V_{CCO}							GND	GND	GND	GND	GND	GND							V_{CCO}	I/O_{201}	I/O_{200}	I/O_{199}
P	I/O_{65}	I/O_{66}	I/O_{67}	V_{CCO}							GND	GND	GND	GND	GND	GND							V_{CCO}	I/O_{196}	V_{CC}	I/O_{198}
R	I/O_{68}	I/O_{69}	I/O_{70}	GND							GND	GND	GND	GND	GND	GND							GND	I/O_{193}	I/O_{194}	I/O_{195}
T	I/O_{71}	I/O_{84}	I/O_{85}	GND							GND	GND	GND	GND	GND	GND							GND	I/O_{178}	I/O_{179}	I/O_{192}
U	I/O_{88}	I/O_{87}	I/O_{86}	NC																			NC	I/O_{177}	I/O_{176}	I/O_{175}
V	I/O_{91}	I/O_{90}	I/O_{89}	V_{CCO}																			V_{CCO}	I/O_{174}	I/O_{173}	I/O_{172}
W	I/O_{94}	I/O_{93}	I/O_{92}	V_{CCO}																			V_{CCO}	I/O_{171}	I/O_{170}	I/O_{169}
Y	I/O_{95}	I/O_{72}	I/O_{73}	I/O_{110}																			I/O_{153}	I/O_{190}	I/O_{191}	I/O_{168}
AA	I/O_{74}	I/O_{75}	I/O_{76}	I/O_{111}																			I/O_{152}	I/O_{187}	I/O_{188}	I/O_{189}
AB	I/O_{77}	I/O_{78}	I/O_{79}	N/C																			NC	I/O_{184}	I/O_{185}	I/O_{186}
AC	I/O_{81}	I/O_{80}	I/O_{108}	N/C	NC	I/O_{112}	I/O_{113}	V_{CCO}	V_{CCO}	NC	GND	GND	V_{CCO}	V_{CCO}	GND	GND	NC	V_{CCO}	V_{CCO}	I/O_{150}	I/O_{151}	NC	NC	I/O_{155}	I/O_{183}	I/O_{182}
AD	I/O_{109}	I/O_{82}	I/O_{83}	I/O_{117}	I/O_{97}	I/O_{100}	I/O_{102}	I/O_{105}	I/O_{120}	I/O_{123}	I/O_{126}	I/O_{129}	I2	I/O_{133}	I/O_{136}	I/O_{139}	I/O_{142}	I/O_{157}	I/O_{159}	I/O_{161}	I/O_{163}	I/O_{166}	I/O_{146}	I/O_{180}	I/O_{181}	I/O_{154}
AE	GND	NC	I/O_{115}	I/O_{116}	I/O_{119}	I/O_{98}	I/O_{101}	I/O_{103}	I/O_{106}	I/O_{121}	I/O_{124}	I/O_{127}	V_{CC}	I/O_{130}	I/O_{134}	I/O_{137}	I/O_{140}	I/O_{143}	I/O_{160}	I/O_{162}	I/O_{165}	I/O_{144}	I/O_{147}	I/O_{148}	NC	GND
AF	GND	GND	I/O_{114}	I/O_{118}	I/O_{96}	I/O_{99}	TMS	I/O_{104}	I/O_{107}	I/O_{122}	I/O_{125}	I/O_{128}	I/O_{131}	I/O_{132}	I/O_{135}	I/O_{138}	I/O_{141}	I/O_{156}	I/O_{158}	TDO	I/O_{164}	I/O_{167}	I/O_{145}	I/O_{149}	GND	GND

5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
256	154	CY37256P160-154AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256P160-154AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256P208-154NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256P256-154BGC	BG292	292-Ball Plastic Ball Grid Array	
	125	CY37256P160-125AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256P160-125AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256P208-125NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256P256-125BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37256P160-125AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37256P160-125AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256P208-125NI	N208	208-Lead Plastic Quad Flat Pack	
		CY37256P256-125BGI	BG292	292-Ball Plastic Ball Grid Array	
		5962-9952302QZC	U162	160-Lead Ceramic Quad Flat Pack	Military
	83	CY37256P160-83AC	A160	160-Lead Thin Quad Flat Pack	Commercial
		CY37256P160-83AXC	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256P208-83NC	N208	208-Lead Plastic Quad Flat Pack	
		CY37256P256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37256P160-83AI	A160	160-Lead Thin Quad Flat Pack	Industrial
		CY37256P160-83AXI	A160	160-Lead Lead Free Thin Quad Flat Pack	
		CY37256P208-83NI	N208	208-Lead Plastic Quad Flat Pack	
		CY37256P256-83BGI	BG292	292-Ball Plastic Ball Grid Array	
		5962-9952301QZC	U162	160-Lead Ceramic Quad Flat Pack	Military
384	125	CY37384P208-125NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37384P256-125BGC	BG292	292-Ball Plastic Ball Grid Array	
	83	CY37384P208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37384P256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37384P208-83NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37384P256-83BGI	BG292	292-Ball Plastic Ball Grid Array	

5.0V Ordering Information (continued)

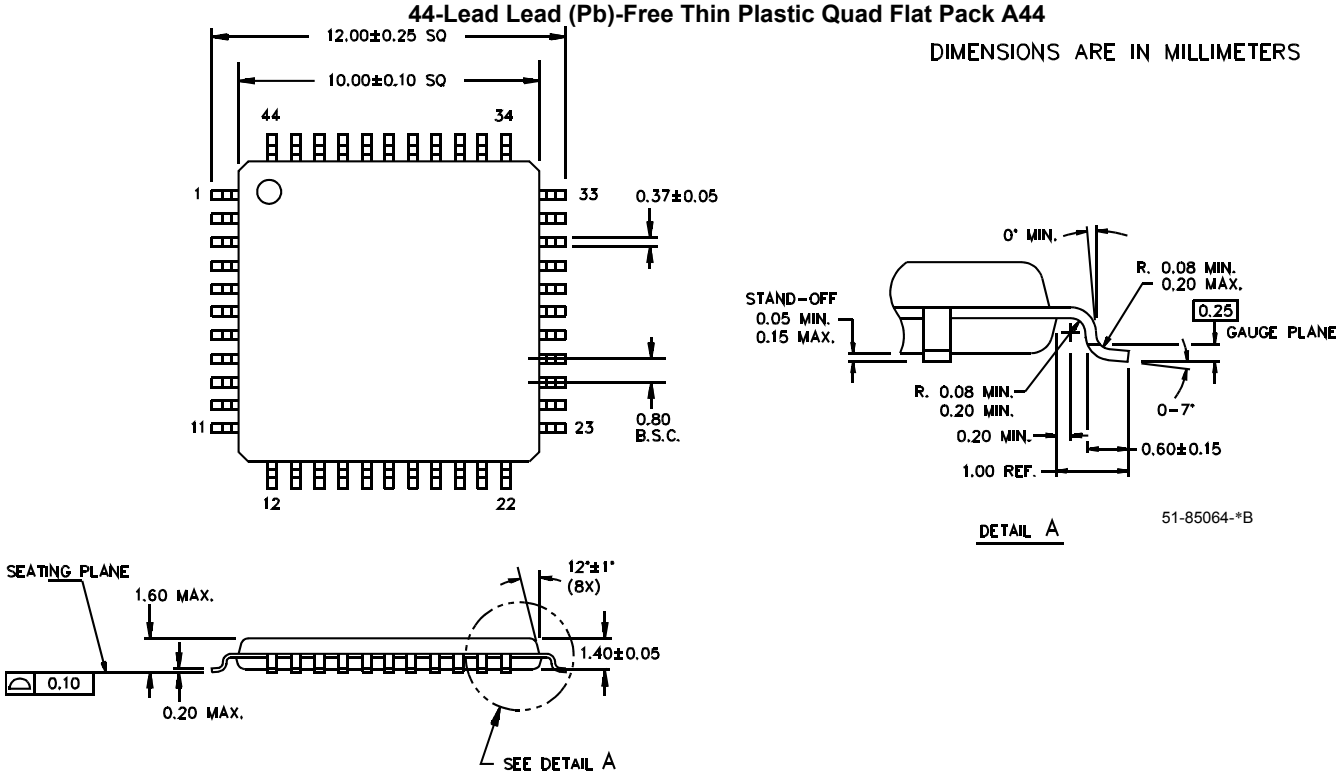
Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
512	125	CY37512P208-125NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-125BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-125BGC	BG388	388-Ball Plastic Ball Grid Array	
	100	CY37512P208-100NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-100BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-100BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512P208-100NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512P256-100BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-100BGI	BG388	388-Ball Plastic Ball Grid Array	
		5962-9952502QZC	U208	208-Lead Ceramic Quad Flat Pack	Military
	83	CY37512P208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial
		CY37512P256-83BGC	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-83BGC	BG388	388-Ball Plastic Ball Grid Array	
		CY37512P208-83NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
		CY37512P256-83BGI	BG292	292-Ball Plastic Ball Grid Array	
		CY37512P352-83BGI	BG388	388-Ball Plastic Ball Grid Array	
		5962-9952501QZC	U208	208-Lead Ceramic Quad Flat Pack	Military

3.3V Ordering Information

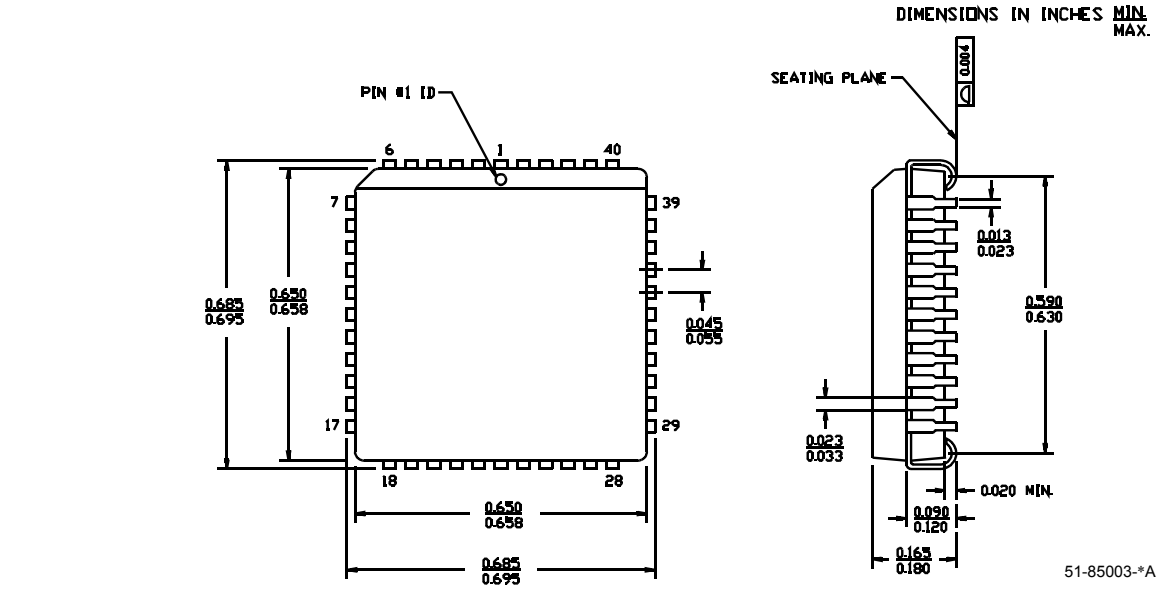
Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
32	143	CY37032VP44-143AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032VP44-143AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-143BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
	100	CY37032VP44-100AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032VP44-100AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-100BAC	BA50	48-Ball Fine Pitch Ball Grid Array	
		CY37032VP44-100AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37032VP44-100AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032VP48-100BAI	BA50	48-Ball Fine Pitch Ball Grid Array	
		CY37032VP44-100JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032VP44-100JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	

Package Diagrams

44-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack A44

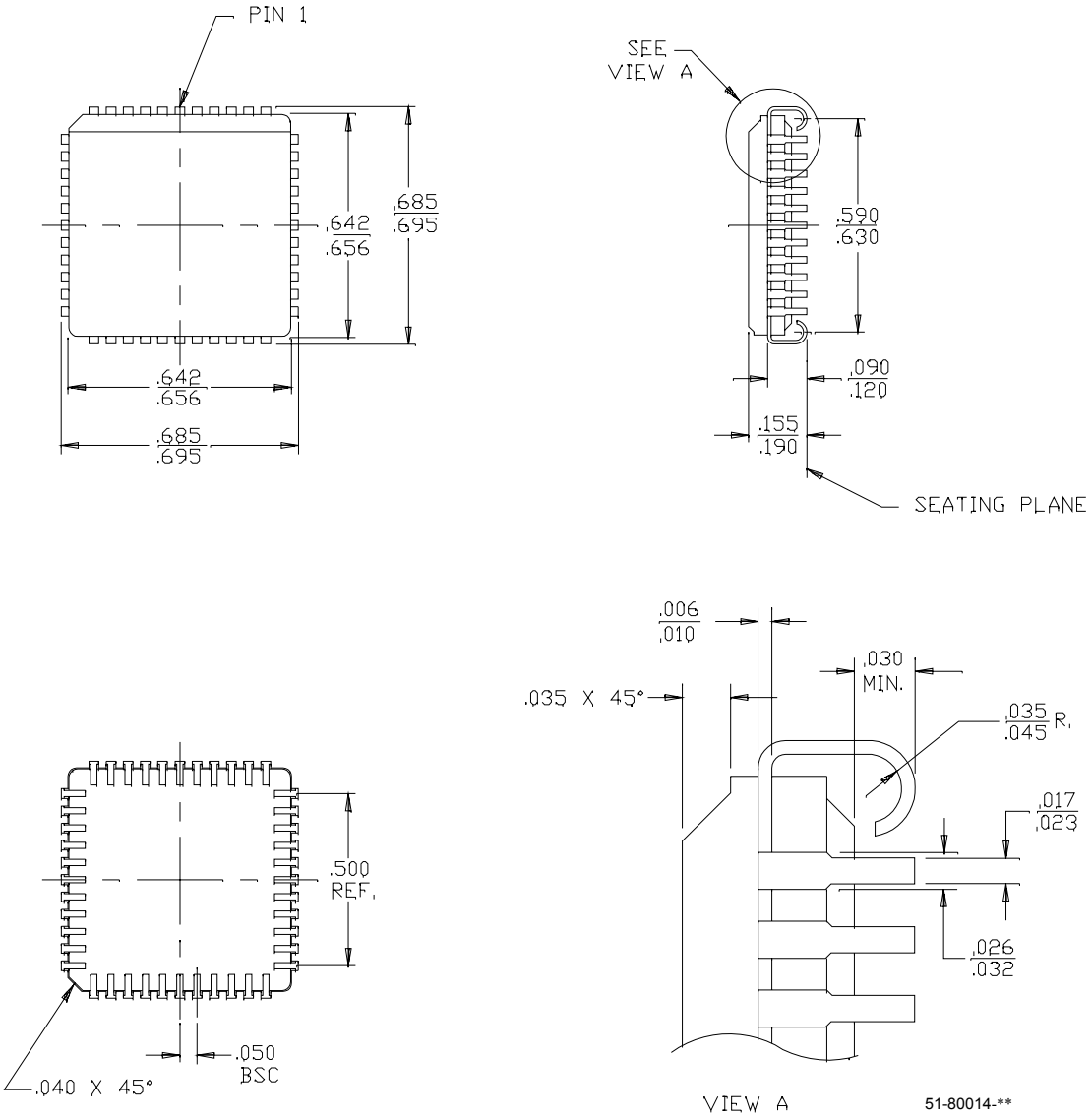


44-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J67



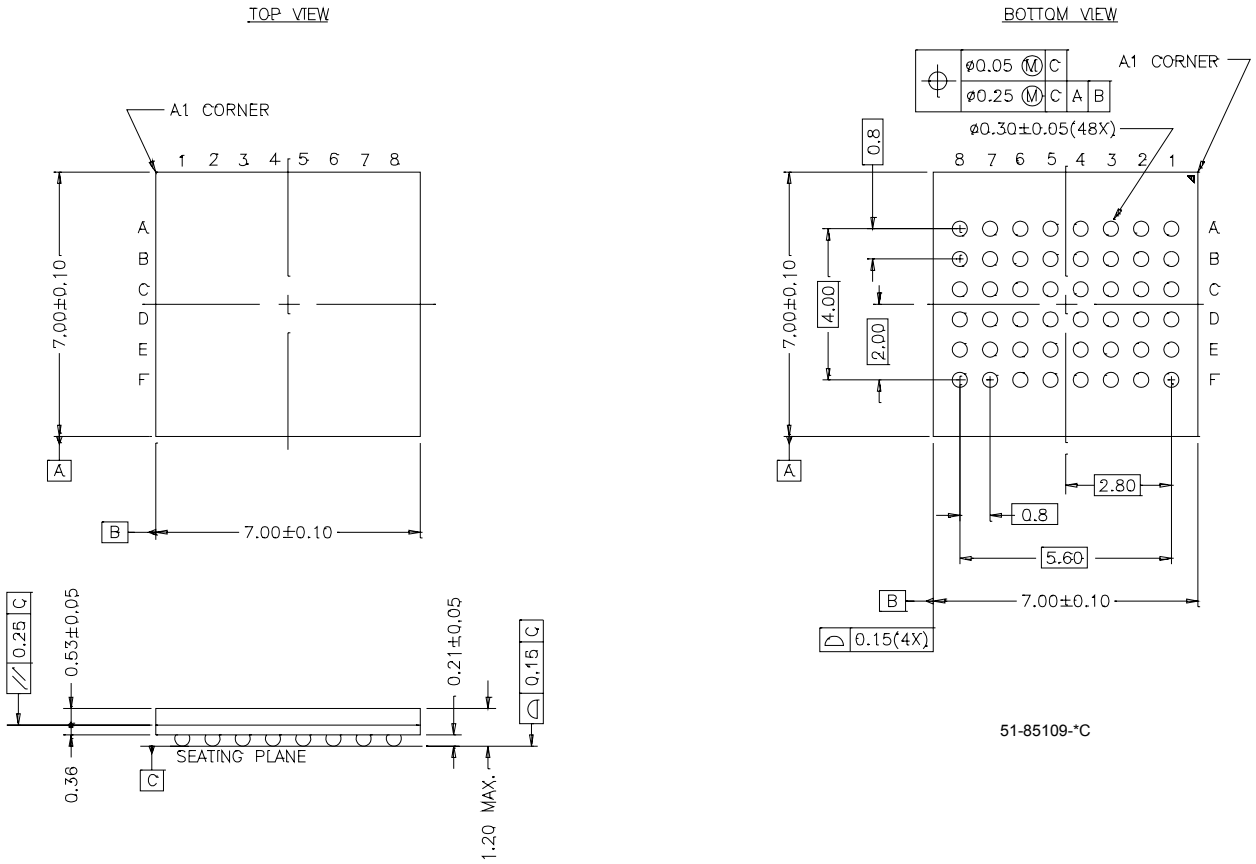
Package Diagrams (continued)

44-Lead Ceramic Leaded Chip Carrier Y67

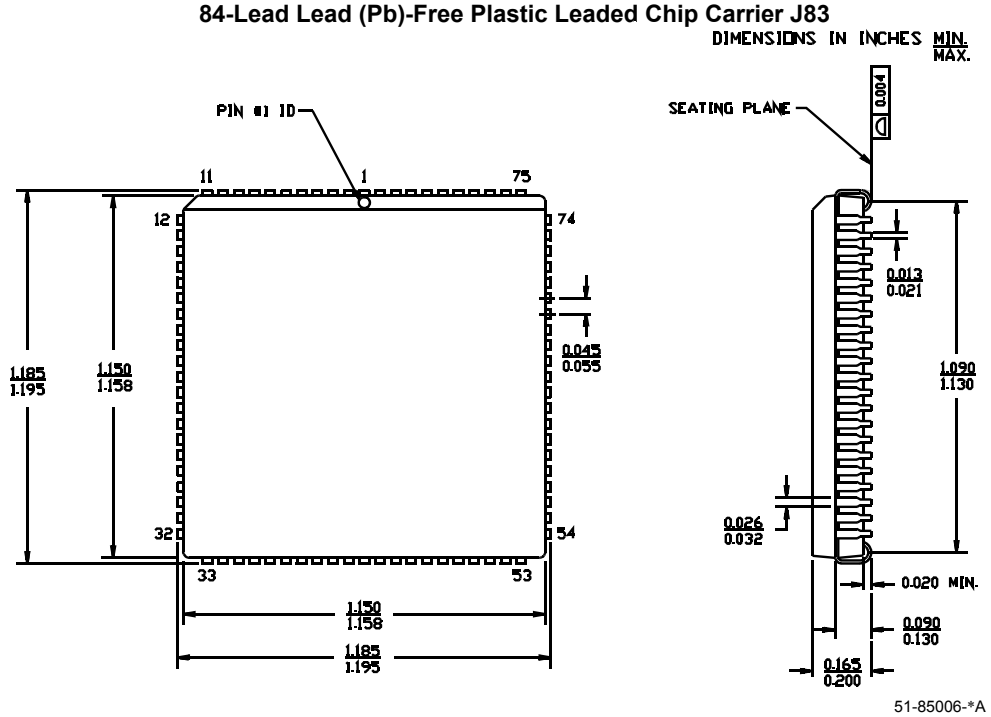


Package Diagrams (continued)

48-Ball (7.0 mm x 7.0 mm x 1.2 mm, 0.80 pitch) Thin BGA BA48D

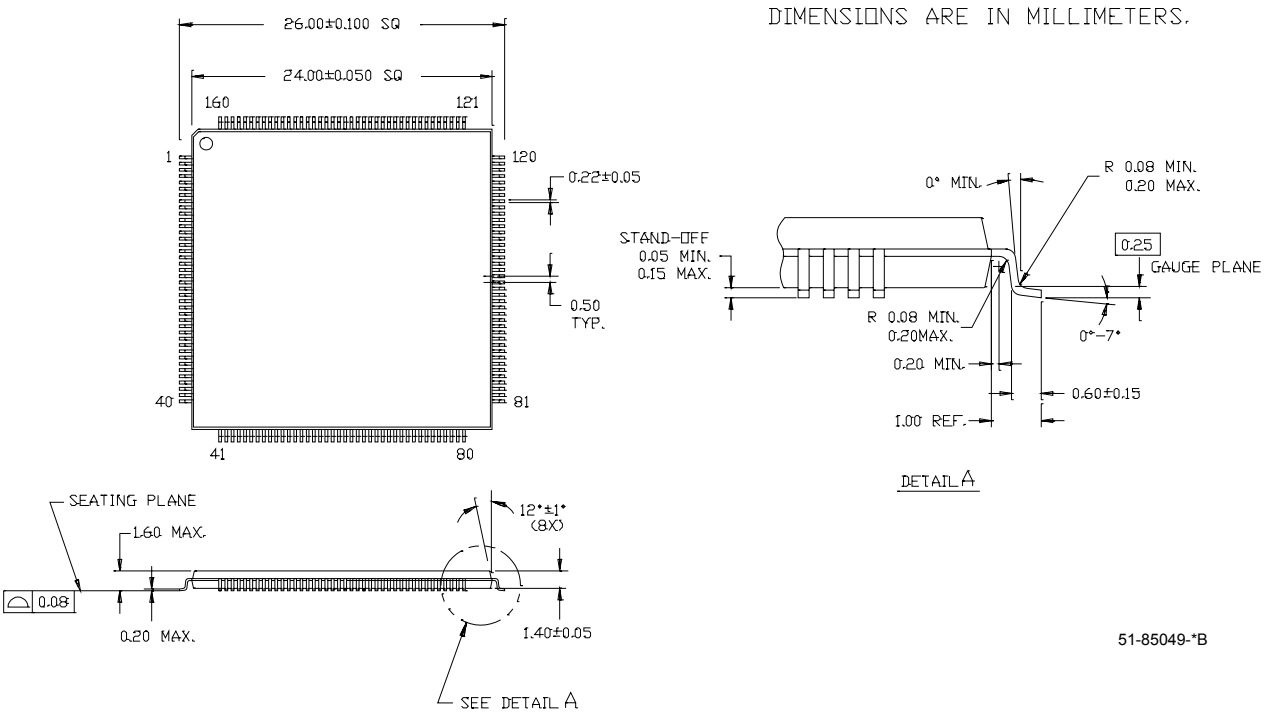


84-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J83



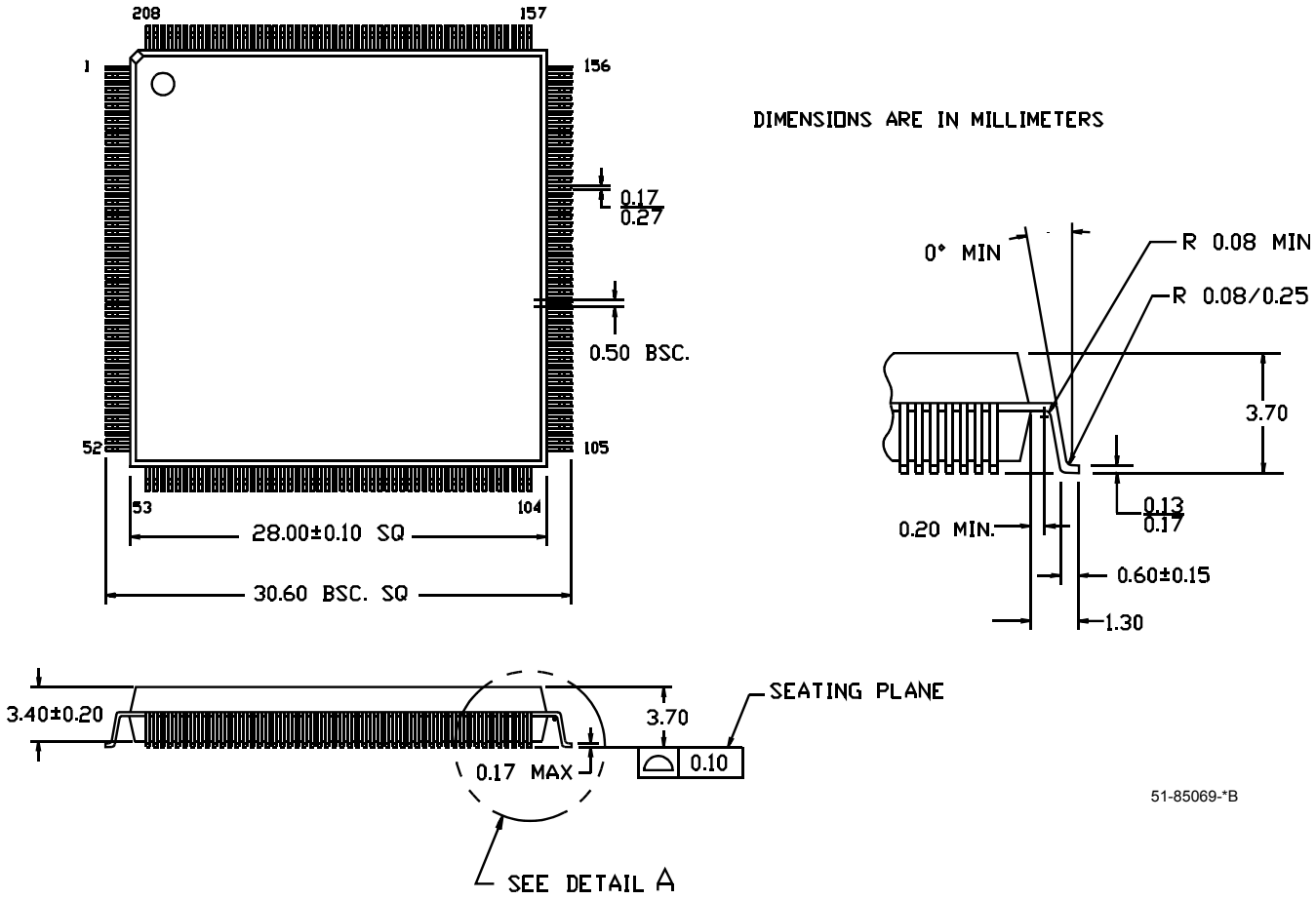
Package Diagrams (continued)

160-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack (24 x 24 x 1.4 mm) (TQFP) A160



Package Diagrams (continued)

208-Lead Plastic Quad Flatpack N208



Document History Page

Document Title: Ultra37000 CPLD Family 5V, 3.3V, ISR™ High-Performance CPLDs Document Number: 38-03007				
REV.	**ECN NO.**	**Issue Date**	**Orig. of Change**	**Description of Change**
**	106272	04/18/01	SZV	Change from Spec number: 38-00475 to 38-03007
*A	124942	03/21/03	OOR	Updated 3.3V V_{CC} requirements for –144 speeds Added an Addendum
*B	126262	05/09/03	TEH	Changed pinout for CY37128V BB100 package
*C	128125	07/16/03	HOM	Obsoleted following 3.3V PLCC packaged devices: CY37032VP44-143JC CY37032VP44-100JC CY37032VP44-100JI CY37064VP44-143JC CY37064VP84-143JC CY37064VP44-100JC CY37064VP84-100JC CY37064VP44-100JI CY37064VP84-100JI CY37128VP84-125JC CY37128VP84-83JC CY37128VP84-83JI
*D	282709	See ECN	YDT	Changed package diagrams and labels for consistency Added Lead (Pb)-free logo on first page, as well as a note in Features Added Lead (Pb)-free package diagram labels Added Lead-free Parts to Ordering Information CY37032P44-200AXC, CY37032P44-200JXC, CY37032P44-154AXI, CY37032P44-154JXI, CY37032P44-125AXC, CY37032P44-125JXC, CY37064P44-200AXC, CY37064P44-200JXC, CY37064P100-200AXC, CY37064P44-154AXI, CY37064P44-154JXI, CY37064P44-125AXC, CY37064P44-125JXC, CY37064P100-125AXC, CY37064P44-125AXI, CY37064P100-125AXI, CY37128P84-167JXC, CY37128P100-167AXC, CY37128P160-167AXC, CY37128P84-125JXC, CY37128P100-125AXC, CY37128P160-125AXC, CY37128P84-125JXI, CY37128P100-125AXI, CY37128P160-125AXI, CY37128P84-100JXC, CY37128P100-100AXC, CY37128P160-100AXC, CY37128P100-100AXI, CY37192P160-154AXC, CY37192P160-125AXC, CY37192P160-125AXI, CY37192P160-83AXC, CY37192P160-83AXI, CY37256P160-154AXC, CY37256P160-125AXC, CY37256P160-125AXI, CY37256P160-83AXC, CY37256P160-83AXI, CY37032VP44-143AXC, CY37032VP44-100AXC, CY37032VP44-100AXI, CY37032VP44-100JXI, CY37064VP44-143AXC, CY37064VP100-143AXC, CY37064VP44-100AXC, CY37064VP100-100AXC, CY37064VP44-100AXI, CY37064VP100-100AXI, CY37128VP100-125AXC, CY37128VP160-125AXC, CY37128VP160-125AXI, CY37128VP100-83AXC, CY37128VP160-83AXC, CY37128VP100-83AXI, CY37128VP160-83AXI, CY37192VP160-100AXC, CY37192VP160-66AXC, CY37256VP160-100AXC, CY37256VP160-100AXI, CY37256VP160-66AXC
*E	321635	See ECN	PCX	Added Package Diagram BG292 Updated all PBGA package type information (BG292 & BG388)